

High Efficiency Standard Rectifier

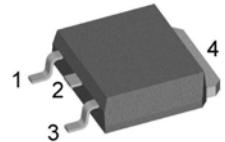
V_{RRM} = 2x 800V
 I_{FAV} = 5A
 V_F = 1.12V

Phase leg

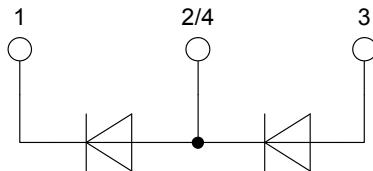
Part number

DLA5P800UC

Marking on Product: M5RLUP



Backside: anode/cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour

Applications:

- Diode for main rectification
- For single and three phase bridge configurations

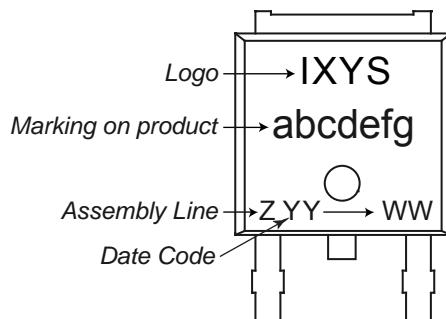
Package: TO-252 (DPak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Rectifier

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			900	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			800	V
I_R	reverse current, drain current	$V_R = 800 V$ $V_R = 800 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$		5 0.05	μA mA
V_F	forward voltage drop	$I_F = 5 A$ $I_F = 10 A$ $I_F = 5 A$ $I_F = 10 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$		1.18 1.38 1.12 1.41	V V V V
I_{FAV}	average forward current	$T_C = 155^\circ C$ 180° sine	$T_{VJ} = 175^\circ C$		5	A
V_{F0} r_F	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 175^\circ C$		0.82 58	V $m\Omega$
R_{thJC}	thermal resistance junction to case				2.5	K/W
R_{thCH}	thermal resistance case to heatsink			0.5		K/W
P_{tot}	total power dissipation		$T_C = 25^\circ C$		60	W
I_{FSM}	max. forward surge current	$t = 10 ms; (50 Hz)$, sine $t = 8,3 ms; (60 Hz)$, sine	$T_{VJ} = 45^\circ C$ $V_R = 0 V$		70 76	A A
		$t = 10 ms; (50 Hz)$, sine $t = 8,3 ms; (60 Hz)$, sine	$T_{VJ} = 150^\circ C$ $V_R = 0 V$		60 64	A A
I^2t	value for fusing	$t = 10 ms; (50 Hz)$, sine $t = 8,3 ms; (60 Hz)$, sine	$T_{VJ} = 45^\circ C$ $V_R = 0 V$		25 24	A^2s A^2s
		$t = 10 ms; (50 Hz)$, sine $t = 8,3 ms; (60 Hz)$, sine	$T_{VJ} = 150^\circ C$ $V_R = 0 V$		18 17	A^2s A^2s
C_J	junction capacitance	$V_R = 400 V$ $f = 1 MHz$	$T_{VJ} = 25^\circ C$	1		pF

Package TO-252 (DPak)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			20	A
T_{stg}	storage temperature		-55		150	°C
T_{VJ}	virtual junction temperature		-55		175	°C
Weight				0.3		g
F_c	mounting force with clip		20		60	N

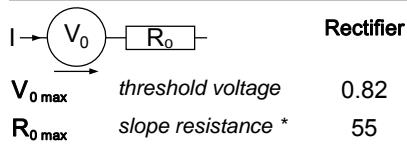
Product Marking**Part number**

D = Diode
 L = High Efficiency Standard Rectifier
 A = (up to 1200V)
 5 = Current Rating [A]
 P = Phase leg
 800 = Reverse Voltage [V]
 UC = TO-252AA (DPak)

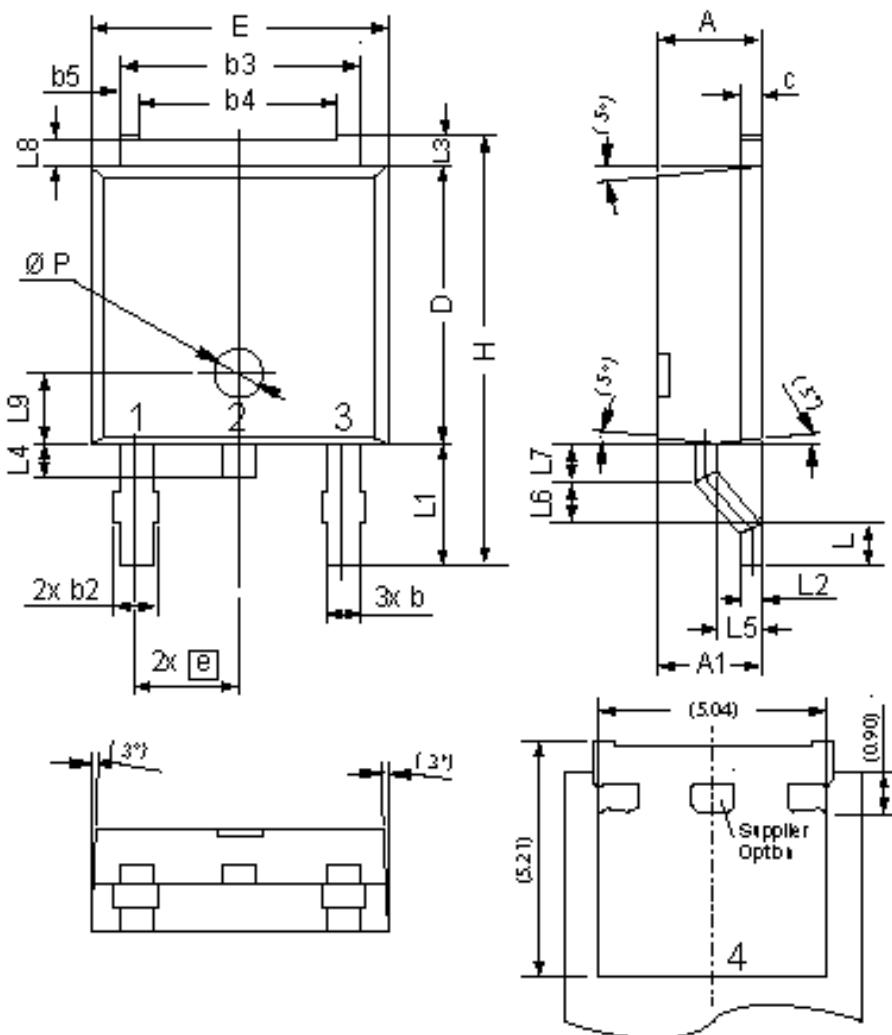
Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DLA5P800UC	M5RLUP	Tape & Reel	2500	511574

Equivalent Circuits for Simulation

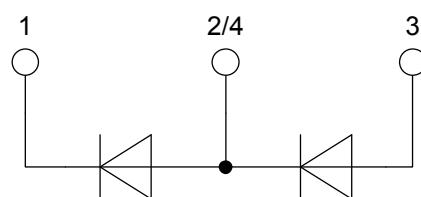
* on die level

 $T_{VJ} = 175^\circ\text{C}$ 

Outlines TO-252 (DPak)



Dim.	Millimeters		Inches	
	min	max	min	max
A	2.20	2.40	0.087	0.094
A1	2.10	2.50	0.083	0.098
b	0.66	0.86	0.026	0.034
b2	-	0.96	-	0.038
b3	5.04	5.64	0.198	0.222
b4	4.34	BSC	0.171	BSC
b5	0.50	BSC	0.020	BSC
c	0.40	0.86	0.016	0.034
D	5.90	6.30	0.232	0.248
E	6.40	6.80	0.252	0.268
e	2.10	2.50	0.083	0.098
H	9.20	10.10	0.362	0.398
L	0.55	1.28	0.022	0.050
L1	2.50	2.90	0.098	0.114
L2	0.40	0.60	0.016	0.024
L3	0.50	0.90	0.020	0.035
L4	0.60	1.00	0.024	0.039
L5	0.82	1.22	0.032	0.048
L6	0.79	0.99	0.031	0.039
L7	0.81	1.01	0.032	0.040
L8	0.40	0.80	0.016	0.031
L9	1.50	BSC	0.059	BSC
Ø P	1.00	BSC	0.039	BSC



Rectifier

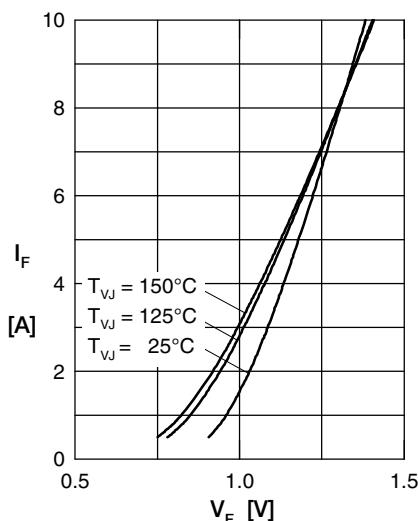


Fig. 1 Forward current versus voltage drop

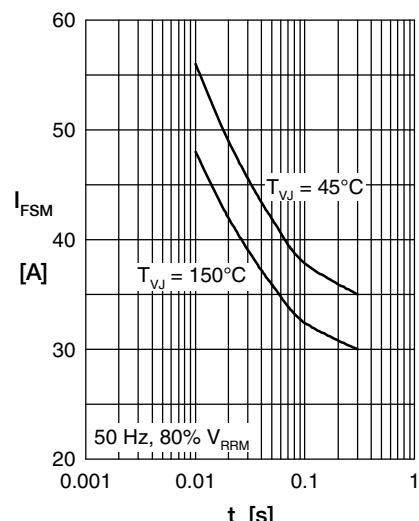


Fig. 2 Surge overload current

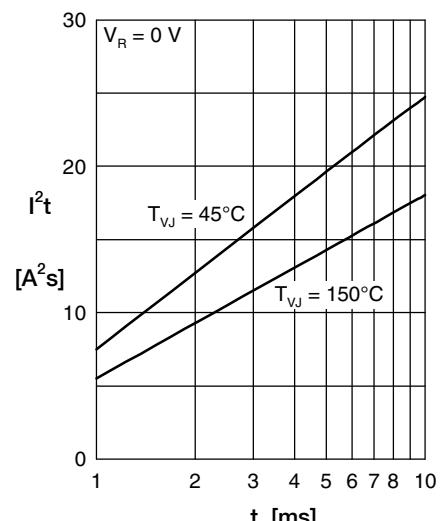
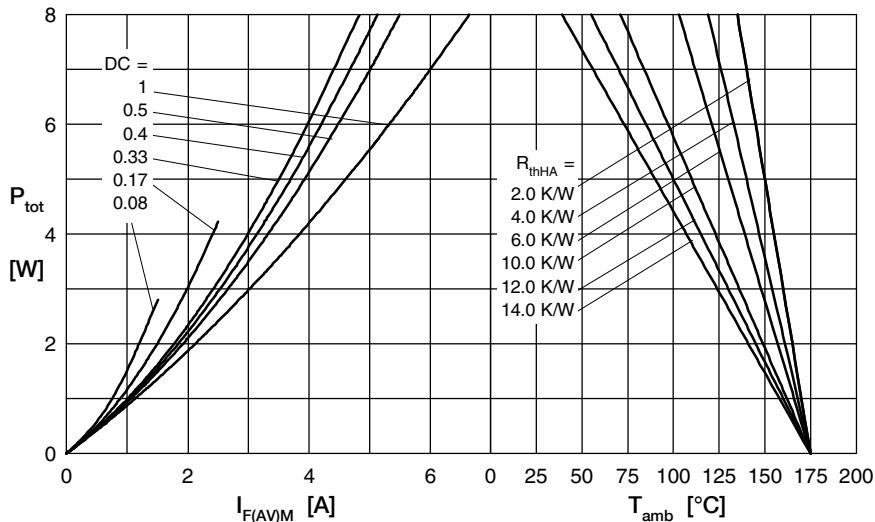
Fig. 3 I^2t versus time

Fig. 4 Power dissipation versus direct output current and ambient temperature

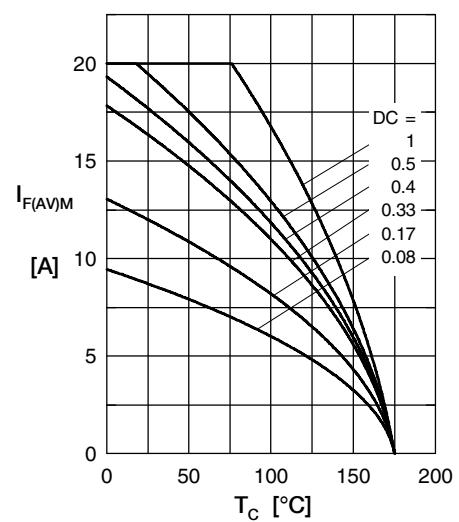


Fig. 5 Max. forward current vs. case temperature

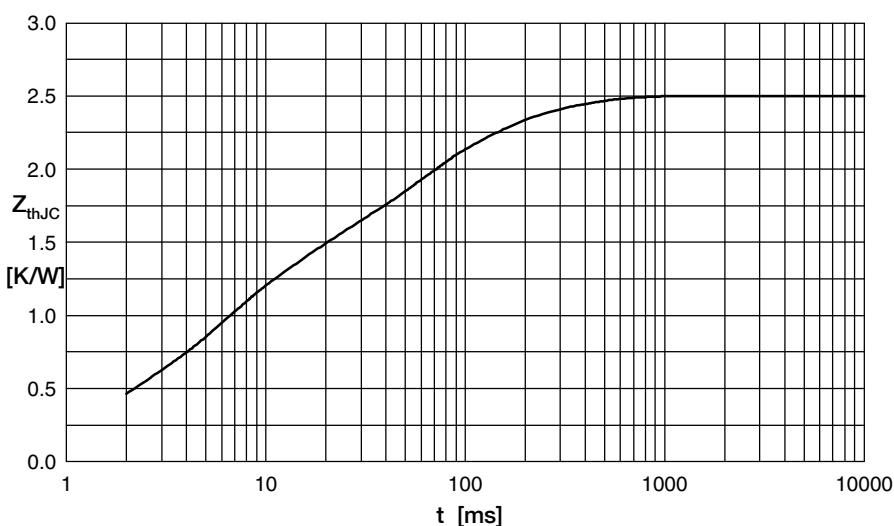


Fig. 6 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	1.1	0.005
2	0.06	0.0003
3	0.2	0.045
4	0.4	0.2
5	0.74	0.05